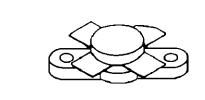


SD1730 (TH560)

RF & MICROWAVE TRANSISTORS HF SSB APPLICATIONS

- OPTIMIZED FOR SSB
- 30 MHz
- 28 VOLTS
- IMD -30dB
- EFFICIENCY 40%
- **COMMON EMITTER**
- GOLD METALLIZATION
- Pout = 220 W PEP WITH 12 dB GAIN



.500 4 LFL (M174) epoxy sealed

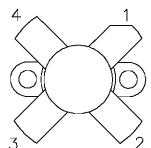
ORDER CODE

SD1730

BRANDING TH560

PIN CONNECTION

4 \rightarrow 1



- 1. Collector
- 3. Base
- 2. Emitter
- 4. Emitter

DESCRIPTION

The SD1730 is a 28 V epitaxial silicon NPN planar transistor designed primarily for SSB and VHF communications. The devices utilizes emitter ballasting for improved ruggedness and reliability.

ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	70	V
V _{CEO}	Collector-Emitter Voltage	35	V
V _{EBO}	Emitter-Base Voltage	4.0	V
Ic	Device Current	16	Α
Poiss	Power Dissipation	320	W
TJ	Junction Temperature	+200	°C
T _{STG}	Storage Temperature	- 65 to +150	°C

THERMAL DATA

R _{TH(j-c)} Junction-Case Thermal Resistance	0.6	°C/W
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ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

STATIC

Symbol	Test Conditions		Value			Unit	
Symbol		rest conditions	rest conditions		Тур.	Max.	
BVces	I _C = 100 mA	$V_{BE} = 0 V$		70	_	_	V
BVceo	I _C = 200 mA	$I_B = 0 \text{ mA}$		35	_	_	V
BV _{EBO}	I _E = 20 mA	$I_C = 0 \text{ mA}$		4.0	_	_	V
I _{CEO}	V _{CE} = 30 V	$I_E = 0 \text{ mA}$		_	_	5	mA
Ices	V _{CE} = 35 V	I _E = 0 mA		_	_	5	mA
h _{FE}	V _{CE} = 5 V	I _C = 7 A		15	_	60	_

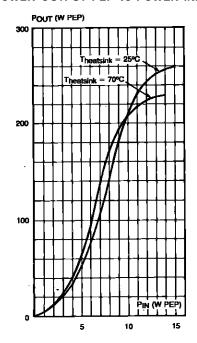
DYNAMIC

Symbol	Test Conditions				Value		
Symbol		rest conditions			Тур.	Max.	Unit
Pout	f = 30 MHz	$V_{CE} = 28 \text{ V}$	$I_{CQ} = 750 \text{ mA}$	220	_	_	W
P _G *	P _{OUT} = 220 W PEP	$V_{CE} = 28 \text{ V}$	$I_{CQ} = 750 \text{ mA}$	12	_	_	dB
IMD*	Pout = 220 W PEP	V _{CE} = 28 V	$I_{CQ} = 750 \text{ mA}$	_	_	-30	dBc
η _C *	Pout = 220 W PEP	Vce = 28 V	$I_{CQ} = 750 \text{ mA}$	40	_	_	%
Сов	f = 1 MHz	$V_{CB} = 28 \text{ V}$		_	450	_	pF
Load Mismatch	P _{OUT} = 220 W PEP	V _{CE} = 28 V	$I_{CQ} = 750 \text{ mA}$	_	∞:1		VSWR

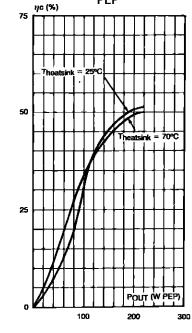
Note: $f_1 = 30.00 \text{ MHz}, f_2 = 30.001 \text{ MHz}$

TYPICAL PERFORMANCE

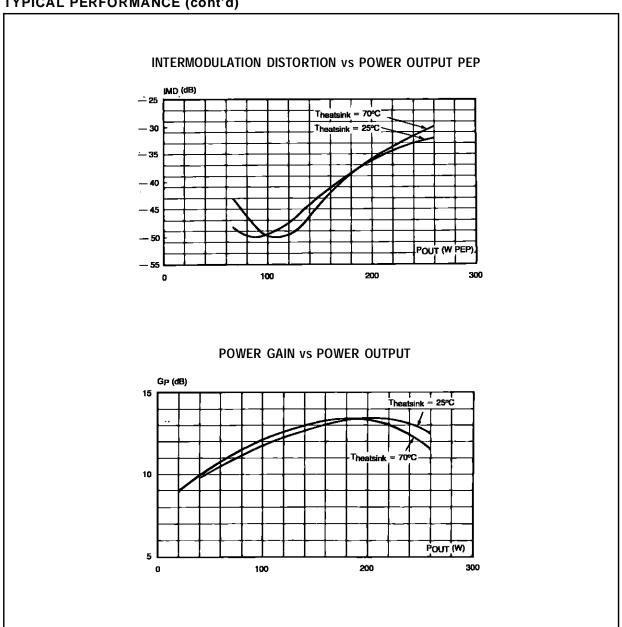
POWER OUTPUT PEP vs POWER INPUT



COLLECTOR EFFICIENCY vs POWER OUTPUT



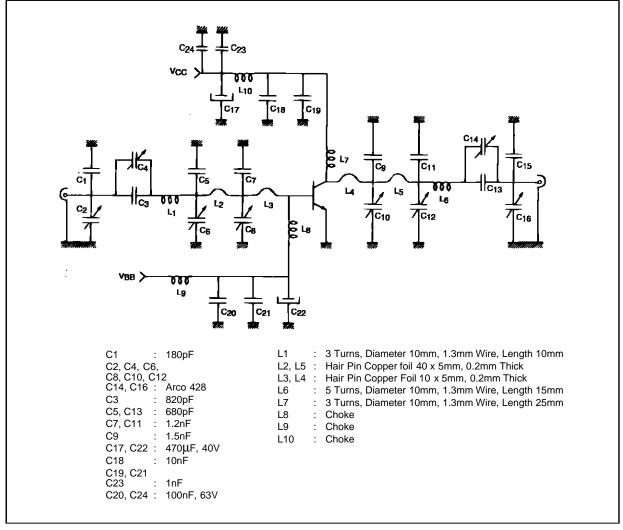
TYPICAL PERFORMANCE (cont'd)

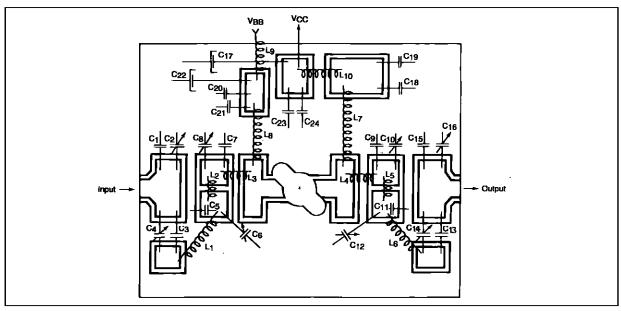


IMPEDANCE DATA

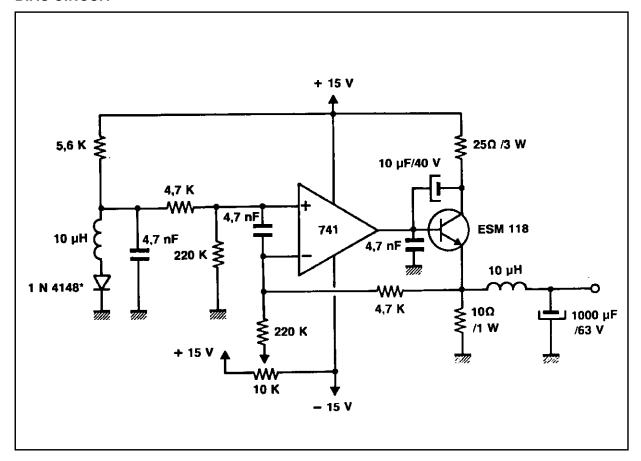
FREQ.	Z_{IN} (Ω)	$Z_CL\ (\Omega)$
30 MHz	1.15 + j 0.41	1.25 + j 1.92

TEST CIRCUIT

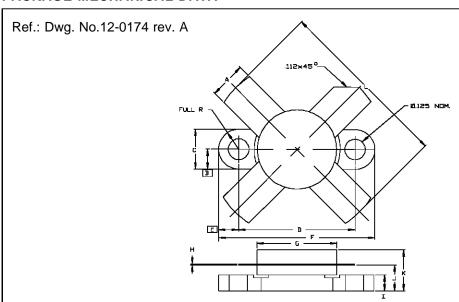




BIAS CIRCUIT



PACKAGE MECHANICAL DATA



,	SGS-THOMSON MICROE	LECTRONICS	1	CI	INT'D
	MINIMUM Inches/mm	MAXIMUM Inches/mm		MININUM Inches/mm	MAXIMUM Inches/mm
Α	.220/5,59	.230/5,84	к		.280/7,11
B	.125/3,19		L		1.050/26,67
С	.245/6,22	.255/6,48			
ם	.720/18,28	.730/18,54			
Ε	.125/3,18				
F	.970/24,64	.980/24,89			
G	.495/12,57	.505/12,83			
Н	.003/0,08	.007/0,18			
I	.090/2,29	.110/2,79			
J	.160/4,06	.175/4,45			

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